UNIKC Semiconductor

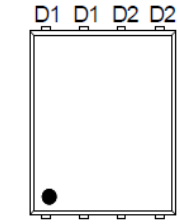
RoHS Compliant

PA010HK

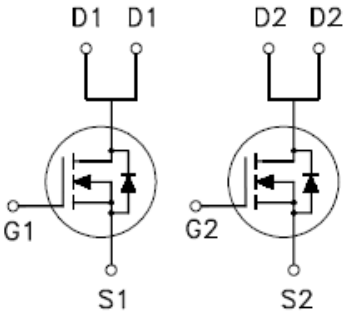
Dual N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	100mΩ @V_{GS} = 10V	9.1A



G. GATE
D. DRAIN
S. SOURCE



PDFN 5*6P

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current	T_C = 25 °C	I_D	9.1	A
	T_C = 100 °C		5.7	
Pulsed Drain Current[1]		I_{DM}	25	
Continuous Drain Current	T_A = 25 °C	I_D	3	
	T_A = 70 °C		2.4	
Avalanche Current		I_{AS}	6	
Avalanche Energy	L = 1mH	E_{AS}	18	mJ
Power Dissipation	T_C = 25 °C	P_D	19	W
	T_C = 100 °C		7.6	
Power Dissipation	T_A = 25 °C	P_D	2	
	T_A = 70 °C		1.3	
Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		6.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$		60	

[1]Pulse width limited by maximum junction temperature.

[2]The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	100			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1	2	3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 80V, V_{GS} = 0V ,			1	μA
		V_{DS} = 80V, V_{GS} = 0V , T_J = 70 °C			10	
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 2A		86	120	mΩ
		V_{GS} = 10V, I_D = 3A		82	100	
Forward Transconductance[1]	g_{fs}	V_{DS} = 10V, I_D = 2A		24		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		618		pF
Output Capacitance	C_{oss}			54		
Reverse Transfer Capacitance	C_{rss}			32		
Gate Resistance	R_g	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		1		Ω
Total Gate Charge[2]	Q_g V_{GS}=10V	V_{DS} = 50V, I_D = 3A		14		nC
	Q_g V_{GS}=4.5V			8		
Gate-Source Charge[2]	Q_{gs}			2		
Gate-Drain Charge[2]	Q_{gd}			5		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DS} = 50V,I_D ≅ 3A, V_{GS}=10V, R_{GEN}= 6Ω		17		nS
Rise Time[2]	t_r			15		
Turn-Off Delay Time[2]	$t_{d(off)}$			35		
Fall Time[2]	t_f			13		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I_S				1.7	A
Forward Voltage[1]	V_{SD}	I_F = 3A, V_{GS} = 0V			1.2	V
Diode Reverse Recovery Time	t_{rr}	I_F = 3A, dI/dt = 100A /μS		24		nS
Diode Reverse Recovery Charge	Q_{rr}			16		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.

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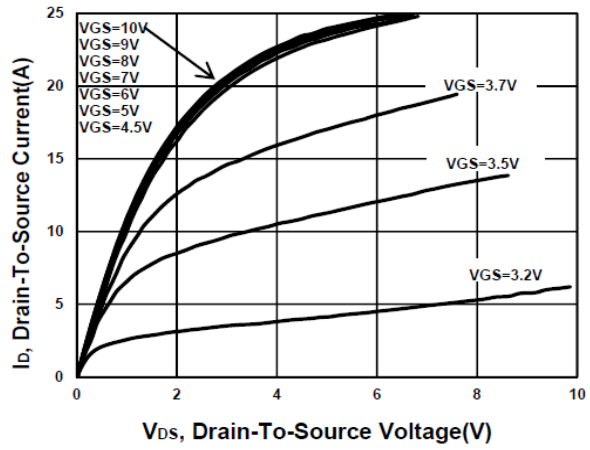
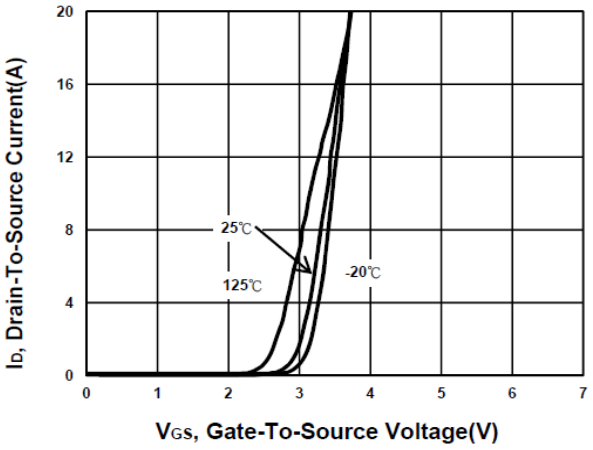
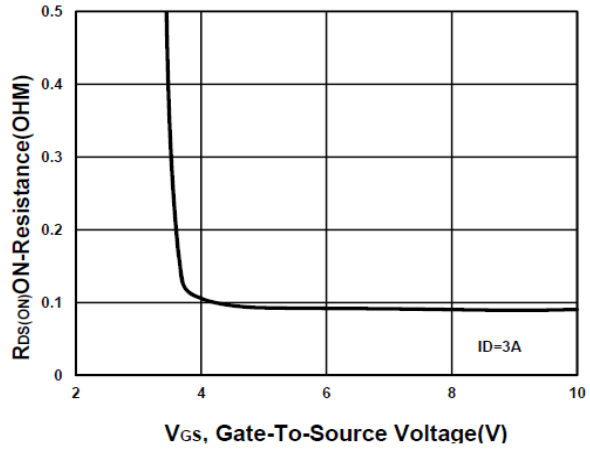
Output Characteristics



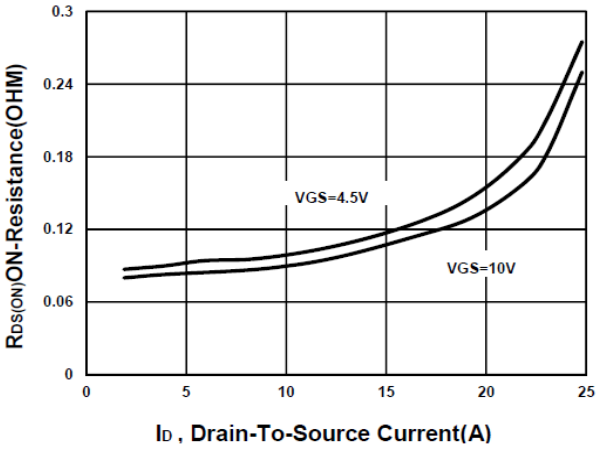
Transfer Characteristics



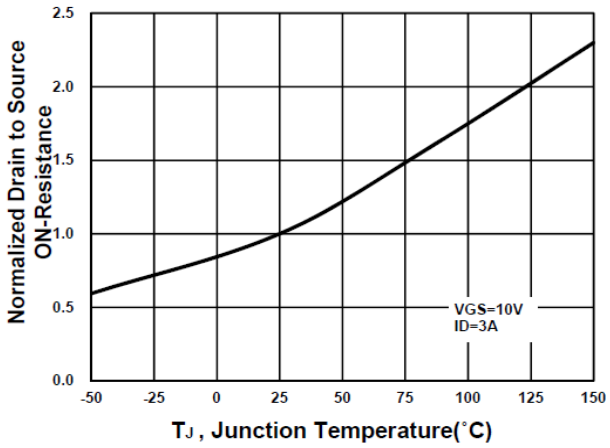
On-Resistance VS Gate-To-Source



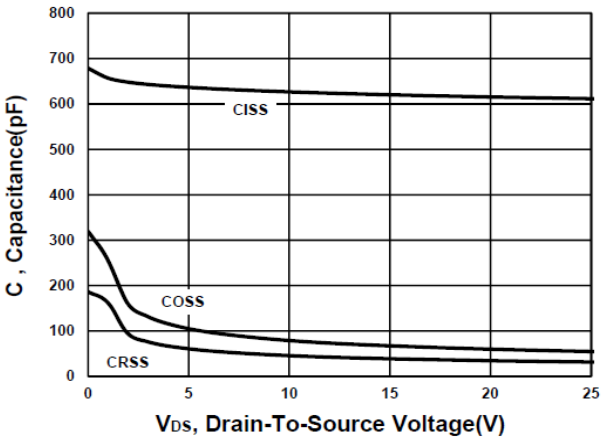
On-Resistance VS Drain Current



On-Resistance VS Temperature



Capacitance Characteristic



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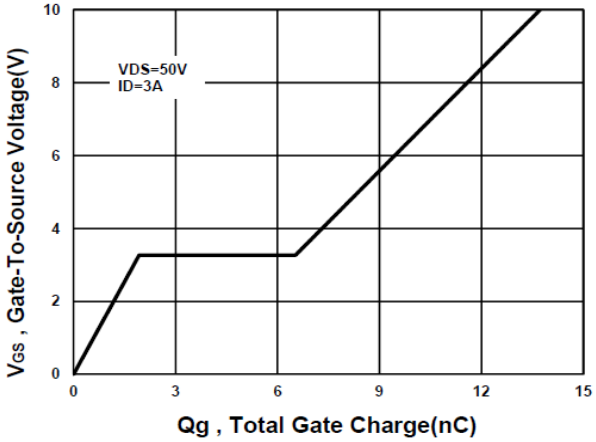
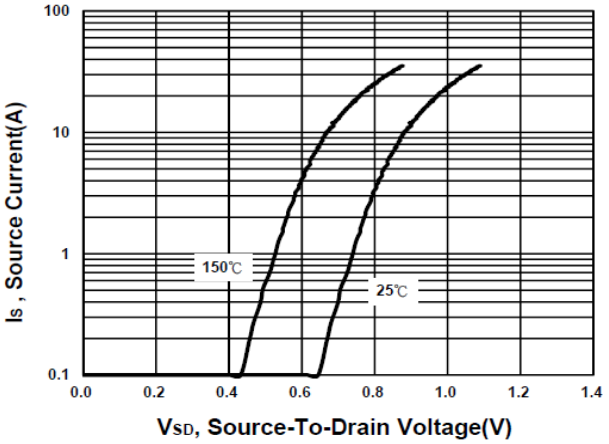
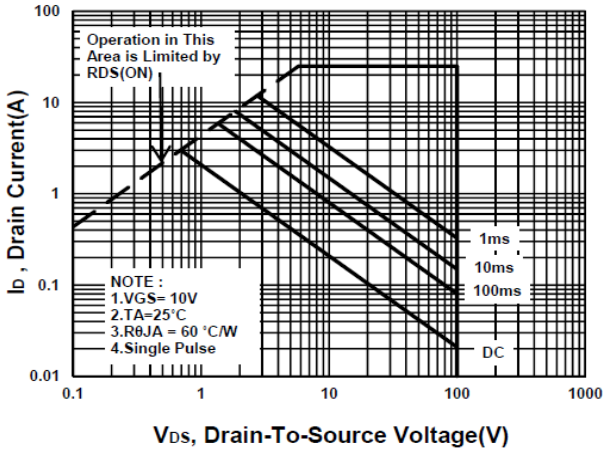
Gate charge Characteristics



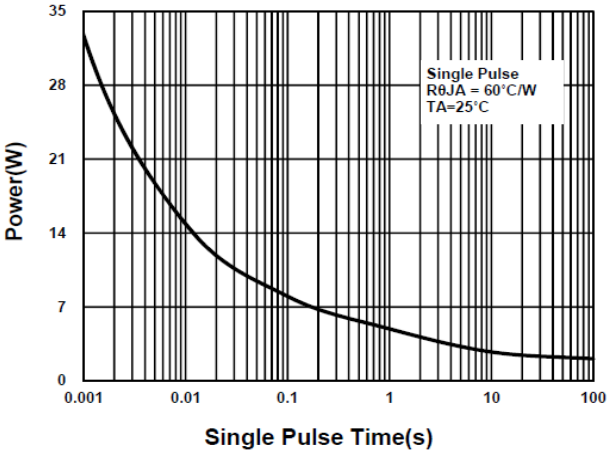
Source-Drain Diode Forward Voltage



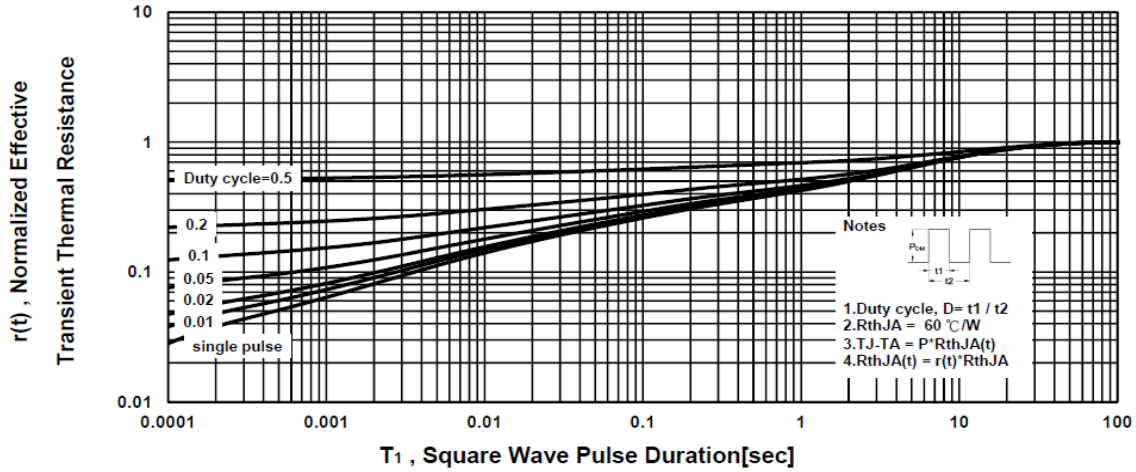
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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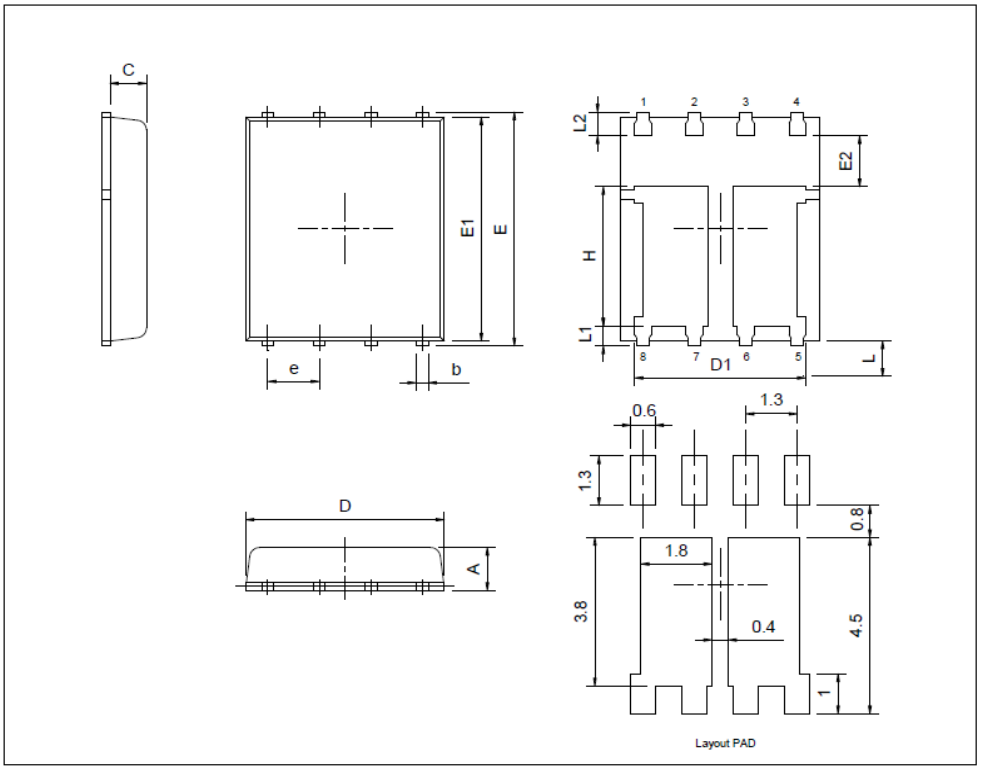
Package Dimension

PDFN 5x6P(左右 Dual) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	0.9		1.17	L	0.05		0.25
b	0.33		0.51	L1	0.38		0.61
C	0.7		0.97	L2	0.38		0.71
D	4.8		5.0	H	3.38		3.78
D1	3.61		4.31				
E	5.9		6.15				
E1	5.65		5.85				
E2	1.1						
e		1.27					



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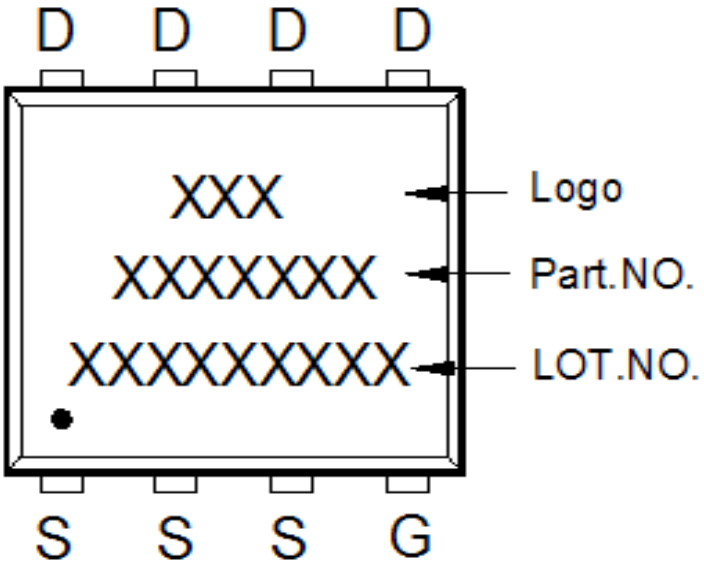
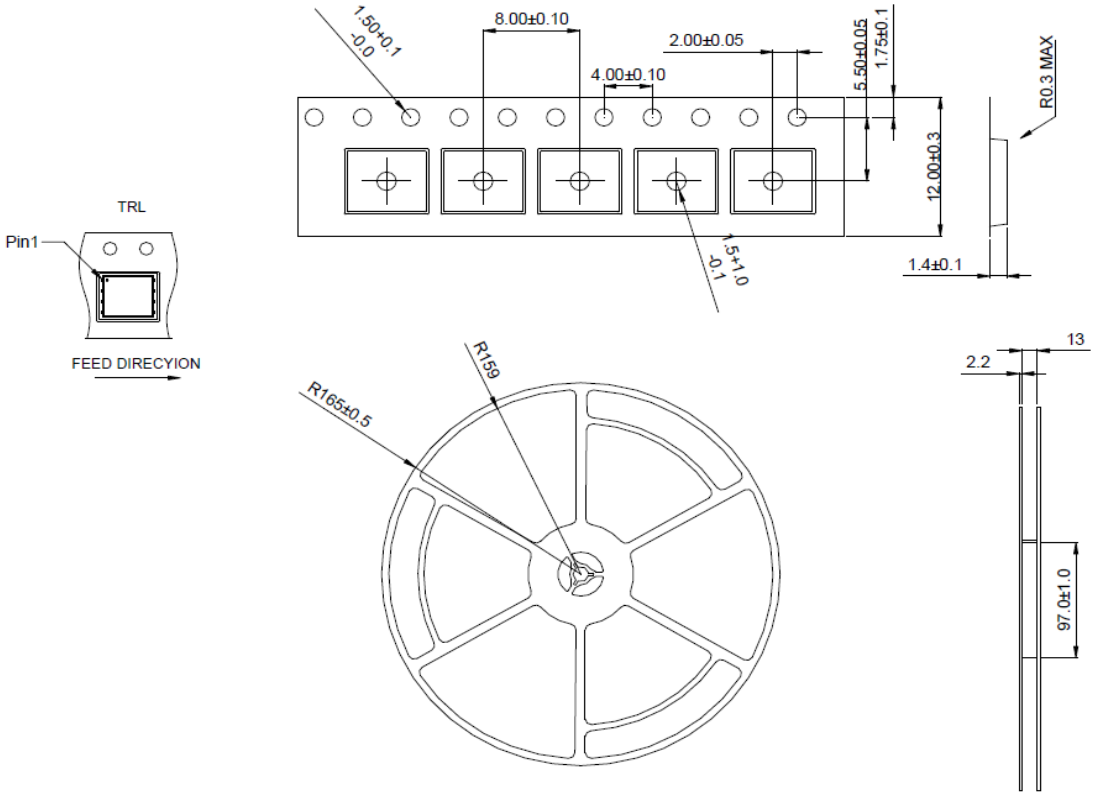
A. Marking Information



B. Tape&Reel Information:3000pcs/Reel



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C. Lot.No. & Date Code rule

1.LOT.NO.

M N 15M21 03

- 03 → #8~9 Sub-lot No
- 15M21 → Order series no.
- N → Foundry site
- M → Assembly site

2.Date Code

D Y M X XXX

- XXX → Order series no. & Sub-lot No
- X → Week
- M → M : Month (A:Jan , B:Feb , C:Mar ,D :Apr ,E:May ,F:Jun,G:Jul,H:Aug,I:Sep,J:Oct,K:Nov,L:Dec.)
- Y → Y : Year (N : 2011, O : 2012 ...)
- D → Assembly site

3.Date Code (for Small package)

XX Y WW

- WW → Week
- Y → Y : Year (9: 2009,A : 2010, B : 2011 ...)
- XX → Device Name

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D.Label rule

标签内容(Label content)

1	Label Size	30 * 90 mm
2	Font style	Times New Roman or Arial （或可区分英文”0”和数字”0”，”G和”Q”的字型即可）
3	Great Power	Height: 4 mm
4	Package	Height: 2 mm
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12
6	Device	Height: 3 mm (Max: 16 Digit)
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot
8	D/C	Height: 3 mm (Max: 7 Digit)
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed
10	Pb Free label	Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
11	Halogen Free label	Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
12	Scan info	Device / Lot / D/C / QTY , Insert “ / “ between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least